



- NOTE:
1. MATERIAL:
 - 1-1 PLASTICS: LCP E4711 WITH 30% GF JUL94V-D, BLACK
 - 1-2 CONTACTS: PHOSPHOR BRONZE
 - 1-3 SHELL: STINNESS
 2. PLATING:
 - 2-1 CONTACTS:
 - 2-1-1 CONTACT AREA: (U)2MIN Gold PLATING ON CONTACT AREA
 - 2-1-2 SOLDER TALL AREA: (U)2MIN Gold PLATING ON CONTACT AREA
 - 2-2 SHELL:
 - 2-2-1 30μ MIN. NICKEL UNDERPLATING OVER ALL PLATING OVER NI 30μ MIN
 - 2-2-2 30μ MIN. NICKEL UNDERPLATING OVER ALL PLATING OVER NI 30μ MIN
 3. CONTACT AND TALL COPLANARITY TO BE 0.10mm MAX.

RECOMMENDED PCB LAYOUT
(TOL:±0.05)

PIN NO	SD NAME	MFC NAME
P1	CD/DAT3	RSV
P2	CMD	CMD
P3	VSS	VSS
P4	VDD	VDD
P5	CLK	CLK
P6	VSS	VSS
P7	DAT0	DAT
P8	DAT1	
P9	DAT2	

WITHOUT CARD	WITH CARD

UNITS: mm		CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE					
X. ° ±5°	0.X ±0.3	PART NO. (INTENDED USE)		TITLE: SD CARD SOCKET SHORT REVERSE H=4.15MM	
X.1 ±2°	0.XX ±0.2	CSD12282041509		DWG NO. SD	
XX. ±1°	0.XXX ±0.1	APPD:	SKILa	SCALE	SHEET
XXX. ±0.5°		DR:	Kitty	1:1	1 OF 1
					REV
					A